

COMBINED DECLARATION/POWER OF ATTORNEY FOR UTILITY/DESIGN PATENT APPLICATION**As an inventor named below, I hereby declare that:**

My residence, post office address and citizenship are as stated below next to my name. I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

PROCESS FOR PREPARING POROUS HYBRID COMPRISING ZEOLITE AND CHITOSAN AND POROUS HYBRID PREPARED THEREBY

the specification of which is attached hereto, unless the following box is checked:

was filed on June 18, 2004 as PCT International Application Number PCT/KR2004/001467 and which has NOT yet been amended.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56.

I hereby claim foreign priority benefit(s) under 35 U.S.C. § 119(a)-(d) or § 365(a)-(c) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application(s) for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)**Priority NOT
Claimed**

<u>10-2003-0039691</u> (Number)	<u>Republic of Korea</u> (Country)	<u>19 June 2003</u> Day/Month/Year Filed	<input type="checkbox"/>
 (Number)	 (Country)	 Day/Month/Year Filed	<input type="checkbox"/>

I hereby claim the benefit under 35 U.S.C. § 120 or § 119(e) of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application(s) in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

<u>PCT/KR2004/001467</u> (Application Serial No.)	<u>18 June 2004</u> (Filing Date)	<u>Pending</u> (Status -- patented, pending, abandoned)
 (Application Serial No.)	 (Filing Date)	 (Status -- patented, pending, abandoned)

I hereby appoint patent attorney RYAN RAFFERTY, USPTO Registration No. 55,556, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and hereby direct that all correspondence be sent to:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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